

Press information

KYOCERA Concludes Agreement to Acquire 100% of Shares in NEC Toppan Circuit Solutions

Kyoto/Neuss — August 6, 2013 — Kyocera Corporation (NYSE: KYO)(TOKYO: 6971) today concluded a share transfer agreement with Toppan Printing Co., Ltd. and NEC Corporation to acquire all shares of the printed circuit board (PCB) manufacturing company NEC Toppan Circuit Solutions, Inc. (herein “TNCSI”) in order to further strengthen and expand the Kyocera Group’s organic substrate business.

Details of the agreement are listed below.

1. Content:	Share transfer agreement concerning NEC TOPPAN CIRCUIT SOLUTIONS, INC.
2. Involved parties:	KYOCERA Corporation; TOPPAN PRINTING CO., LTD.; NEC Corporation
3. Date of agreement:	August 6, 2013
4. Target company:	Company name: NEC TOPPAN CIRCUIT SOLUTIONS, INC. Shareholders: TOPPAN PRINTING CO., LTD. (55%); NEC Corporation (45%) Operations: High-density multilayer PCBs for industrial applications, build-up PCBs for consumer applications, module PCBs

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Press information

5.Transaction schedule:	October 1, 2013: <ul style="list-style-type: none">- All shares of TNCSi to be transferred to KYOCERA Corporation- TNCSi to become wholly owned subsidiary of KYOCERA Corporation
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6. Motive and intent:

The market for PCBs is forecast to continue expanding steadily on the back of growing demand for telecommunications infrastructure equipment, and digital consumer electronics — centered on smartphones and mobile computing tablets.

The Kyocera Group has been expanding its business in the PCB market focusing on organic packages sold by its wholly owned subsidiary, Kyocera SLC Technologies (herein “KST”), which boasts one of the highest shares in the industry for FC-BGAs^{*1} used in high-end ASIC applications. KST also plans to expand its business territory through the recent full-fledged launch of smaller, lower profile FC-CSPs^{*2} for the high-growth smartphone and mobile computing tablet sectors.

Alternatively, TNCSi has focused its business in the PCB market on the motherboard field, by widely expanding its business territory by developing, manufacturing and selling extremely low profile and multilayer boards used in products ranging from high-end telecommunications infrastructure equipment, module PCBs used in smartphones, and PCBs for in-vehicle applications. By utilizing the company’s broad range of high-density PCBs and its high level of

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technology for low profile substrates, TNCSi has recently been developing some of the world's lowest profile component-embedded PCBs which are expected to contribute to the further downsizing of smartphones and other electronics.

Through the acquisition of TNCSi, Kyocera will be able to further develop its business offerings and contribute to overall business expansion. The synergies created through combining the two companies' technologies will allow for the development of new products to meet customers' needs. With the Kyocera Group's global sales network and TNCSi's stable customer base, Kyocera will utilize both companies' management resources to the fullest and aim to further expand its organic substrate business in the future.

Reference:

<i>Trade name</i>	NEC TOPPAN CIRCUIT SOLUTIONS, INC.
<i>Established</i>	October 1, 2002
<i>Headquarters</i>	19-26 Shibaura 3-chome, Minato-ku, Tokyo, Japan
<i>Representative</i>	President: Keiji Miyajima
<i>Operations</i>	Development, design, manufacture and sales of printed circuit boards
<i>Capital</i>	1 billion yen
<i>Controlling share</i>	TOPPAN PRINTING CO., LTD.: 55%; NEC Corporation: 45%
<i>Employees</i>	Non-consolidated: 769; consolidated: 1,133 (as of July 31, 2013)
<i>Main facilities</i>	Manufacturing plants: 2 in Japan (Niigata, Toyama); 1 in Philippines Sales offices: 4 in Japan (2 in Tokyo; Nagoya, Osaka); 2 in U.S.A. (San Diego, San Jose)

*1 FC-BGA (flip-chip ball grid array) packaging substrates for high-end ASICs are organic substrates for specific applications, such as host servers and network equipment in banks or brokerage houses for which high speed data processing and high reliability are required.

*2 FC-CSP (flip-chip chip scale packaging) substrates are organic packaging substrates applied as core components in application processors or baseband processors for smartphones and mobile

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computing tablets.

For more information about Kyocera: www.kyocera.eu

About Kyocera

Headquartered in Kyoto, Japan, Kyocera Corporation is one of the world's leading manufacturers of fine ceramic components for the technology industry. The strategically important divisions in the Kyocera Group, which is comprised of 228 subsidiaries (as of April 1, 2013), are information and communications technologies, products which increase quality of life, and environmentally friendly products. The technology group is also one of the largest producers of solar energy systems worldwide, with more than 3,0 gigawatts of solar power having been installed around the world to date.

The company is ranked #492 on *Forbes* magazine's 2013 "Global 2000" listing of the world's largest publicly traded companies.

With a global workforce of about 71,000 employees, Kyocera posted net sales of approximately €10.58 billion in fiscal year 2012/2013. The products marketed by the company in Europe include laser printers, digital copying systems, microelectronic components, fineceramic products and complete solar power systems. The Kyocera Group has two independent companies in the Federal Republic of Germany: Kyocera Fineceramics GmbH in Neuss and Esslingen and Kyocera Document Solutions in Meerbusch.

The company also takes an active interest in cultural affairs. The Kyoto Prize, a prominent international award, is presented each year by the Inamori Foundation — established by Kyocera founder Dr. Kazuo Inamori — to individuals and groups worldwide who have contributed significantly to the scientific, cultural, and spiritual betterment of humankind (converted at present €400,000 per prize category).

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